

April 2014

2N3906 / MMBT3906 / PZT3906 PNP General-Purpose Amplifier

Description

This device is designed for general-purpose amplifier and switching applications at collector currents of 10 mA to 100 mA.



Ordering Information

Part Number	Marking	Package	Packing Method	Pack Quantity
2N3906BU	2N3906	TO-92 3L	Bulk	10000
2N3906TA	2N3906	TO-92 3L	Ammo	2000
2N3906TAR	2N3906	TO-92 3L	Ammo	2000
2N3906TF	2N3906	TO-92 3L	Tape and Reel 2000	
2N3906TFR	2N3906	TO-92 3L	Tape and Reel 2000	
MMBT3906	2A	SOT-23 3L	Tape and Reel	3000
PZT3906	3906	SOT-223 4L	Tape and Reel	2500

1

Absolute Maximum Ratings(1)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Value	Unit
V _{CEO}	Collector-Emitter Voltage	-40	V
V _{CBO}	Collector-Base Voltage	-40	V
V _{EBO}	Emitter-Base Voltage	-5.0	V
I _C	Collector Current - Continuous	-200	mA
T _{J,} T _{STG}	Operating and Storage Junction Temperature Range	-55 to +150	°C

Note:

1. These ratings are based on a maximum junction temperature of 150°C.

These are steady-state limits. Fairchild Semiconductor should be consulted on applications involving pulsed or low-duty cycle operations.

Thermal Characteristics

Values are at $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Maximum			Unit
		2N3906 ⁽³⁾	MMBT3906 ⁽²⁾	PZT3906 ⁽³⁾	Oilit
В	Total Device Dissipation	625	350	1,000	mW
P _D	Derate Above 25°C	5.0	2.8	8.0	mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	83.3			°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	357	125	°C/W

Notes:

- 2. Device is mounted on FR-4 PCB 1.6 inch X 1.6 inch X 0.06 inch.
- 3. PCB size: FR-4, 76 mm x 114 mm x 1.57 mm (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.

Electrical Characteristics

Values are at $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Max.	Unit	
OFF CHAR	ACTERISTICS			•		
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage ⁽⁴⁾	I _C = -1.0 mA, I _B = 0	-40		V	
V _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_C = -10 \mu\text{A}, \ I_E = 0$	-40		V	
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_E = -10 \mu A, I_C = 0$	-5.0		V	
I _{BL}	Base Cut-Off Current	$V_{CE} = -30 \text{ V}, V_{BE} = 3.0 \text{ V}$		-50	nA	
I _{CEX}	Collector Cut-Off Current	$V_{CE} = -30 \text{ V}, V_{BE} = 3.0 \text{ V}$		-50	nA	
ON CHARA	CTERISTICS			•	•	
		$I_C = -0.1 \text{ mA}, V_{CE} = -1.0 \text{ V}$	60			
		$I_C = -1.0 \text{ mA}, V_{CE} = -1.0 \text{ V}$	80			
h _{FE}	DC Current Gain ⁽⁴⁾	$I_C = -10 \text{ mA}, V_{CE} = -1.0 \text{ V}$	100	300		
		$I_C = -50 \text{ mA}, V_{CE} = -1.0 \text{ V}$	60			
		$I_C = -100 \text{ mA}, V_{CE} = -1.0V$	30			
\/ (aat)	Collector-Emitter Saturation	$I_C = -10 \text{ mA}, I_B = -1.0 \text{ mA}$		-0.25	V	
V _{CE} (sat)	Voltage	$I_C = -50 \text{ mA}, I_B = -5.0 \text{ mA}$		-0.40		
\/ (aat)	5 5 111 6 1 11 14 11	$I_C = -10 \text{ mA}, I_B = -1.0 \text{ mA}$	-0.65	-0.85	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	
V _{BE} (sat)	Base-Emitter Saturation Voltage	$I_C = -50 \text{ mA}, I_B = -5.0 \text{ mA}$		-0.95	- V	
SMALL SIG	NAL CHARACTERISTICS			•	•	
f _T	Current Gain - Bandwidth Product	I _C = -10 mA, V _{CE} = -20 V, f = 100 MHz	250		MHz	
C _{obo}	Output Capacitance	V _{CB} = -5.0 V, I _E = 0, f = 100 kHz		4.5	pF	
C _{ibo}	Input Capacitance	V _{EB} = -0.5 V, I _C = 0, f = 100 kHz		10.0	pF	
NF	Noise Figure	I_{C} = -100 μ A, V_{CE} = -5.0 V, R_{S} = 1.0 k Ω , f = 10 Hz to 15.7 kHz		4.0	dB	
SWITCHING	CHARACTERISTICS	<u>'</u>		•		
t _d	Delay Time	$V_{CC} = -3.0 \text{ V}, V_{BE} = -0.5 \text{ V}$	A	35	ns	
t _r	Rise Time	I _C = -10 mA, I _{B1} = -1.0 mA		35	ns	
t _s	Storage Time	$V_{CC} = -3.0 \text{ V}, I_{C} = -10 \text{ mA},$		225	ns	
t _f	Fall Time	$I_{B1} = I_{B2} = -1.0 \text{ mA}$		75	ns	

Note:

4. Pulse test: pulse width $\leq 300~\mu s,$ duty cycle $\leq 2.0\%.$

Typical Performance Characteristics

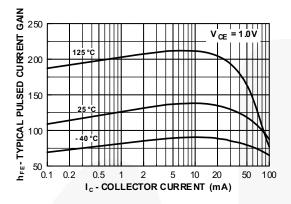


Figure 1. Typical Pulsed Current Gain vs. Collector Current

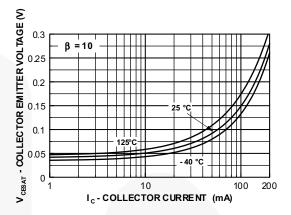


Figure 2. Collector-Emitter Saturation Voltage vs.
Collector Current

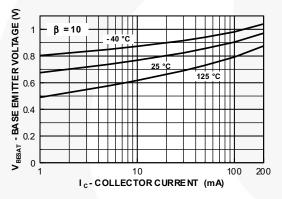


Figure 3. Base-Emitter Saturation Voltage vs. Collector Current

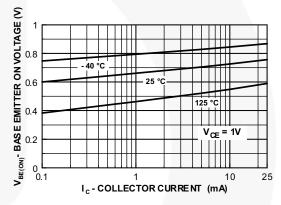


Figure 4. Base-Emitter On Voltage vs. Collector Current

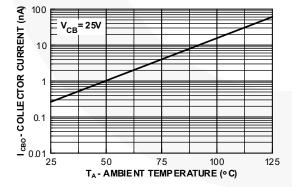


Figure 5. Collector Cut-Off Current vs.
Ambient Temperature

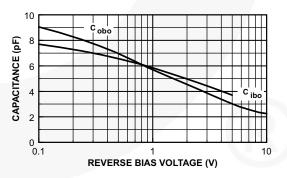


Figure 6. Common-Base Open Circuit Input and Output Capacitance vs. Reverse Bias Voltage

Typical Performance Characteristics (Continued)

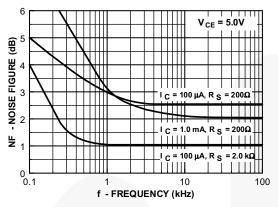


Figure 7. Noise Figure vs. Frequency

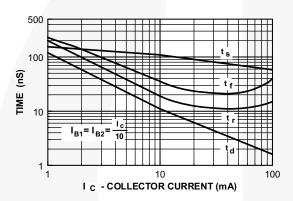


Figure 9. Switching Times vs. Collector Current

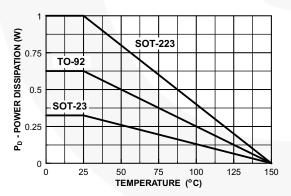


Figure 11. Power Dissipation vs. Ambient Temperature

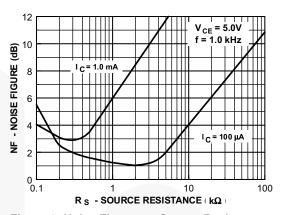


Figure 8. Noise Figure vs. Source Resistance

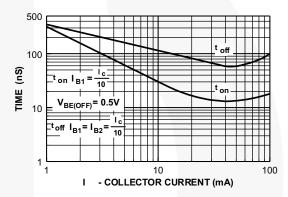


Figure 10. Turn-On and Turn-Off Times vs. Collector Current

Typical Performance Characteristics (Continued)

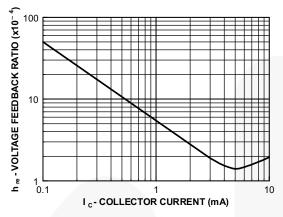


Figure 12. Voltage Feedback Ratio

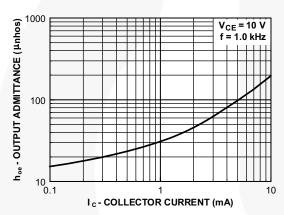


Figure 14. Output Admittance

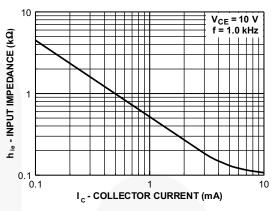


Figure 13. Input Impedance

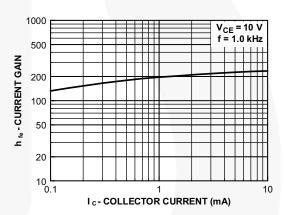


Figure 15. Current Gain

Physical Dimensions

TO-92 (Bulk)

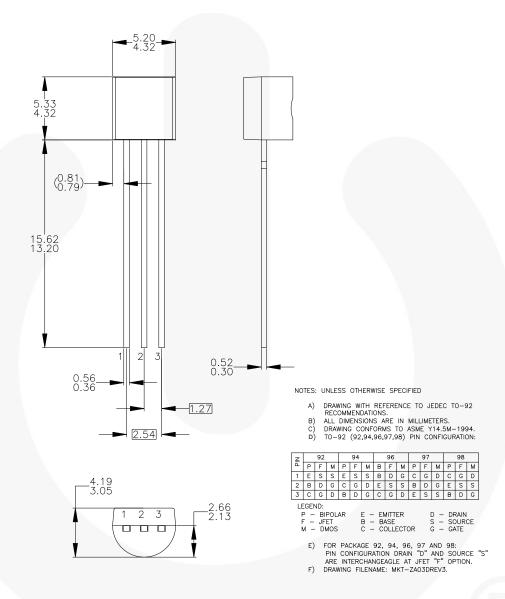


Figure 16. 3-LEAD, TO92, JEDEC TO-92 COMPLIANT STRAIGHT LEAD CONFIGURATION (OLD TO92AM3)

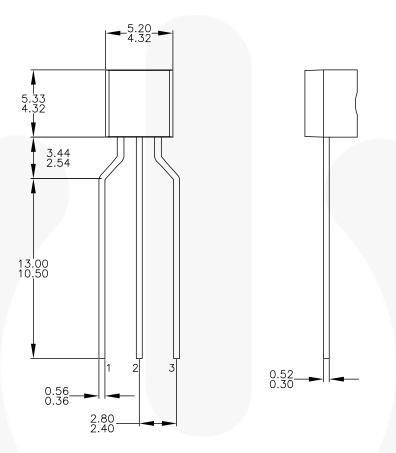
Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

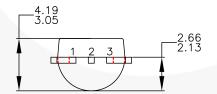
Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: http://www.fairchildsemi.com/dwg/ZA/ZA03D.pdf.

For current tape and reel specifications, visit Fairchild Semiconductor's online packaging area: http://www.fairchildsemi.com/packing_dwg/PKG-ZA03D_BK.pdf.

Physical Dimensions (Continued)

TO-92 (Ammo, Tape and Reel)





NOTES: UNLESS OTHERWISE SPECIFIED

- DRAWING CONFORMS TO JEDEC MS-013, VARIATION AC.
 ALL DIMENSIONS ARE IN MILLIMETERS.
 DRAWING CONFORMS TO ASME Y14.5M-2009.
 DRAWING FILENAME: MKT-ZAO3FREV3.
 FAIRCHILD SEMICONDUCTOR.

Figure 17. 3-LEAD, TO92, MOLDED 0.200 IN LINE SPACING LEAD FORM (J61Z OPTION)

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: http://www.fairchildsemi.com/dwq/ZA/ZA03F.pdf.

For current tape and reel specifications, visit Fairchild Semiconductor's online packaging area: http://www.fairchildsemi.com/packing_dwg/PKG-ZA03F_BK.pdf.

Physical Dimensions (Continued)

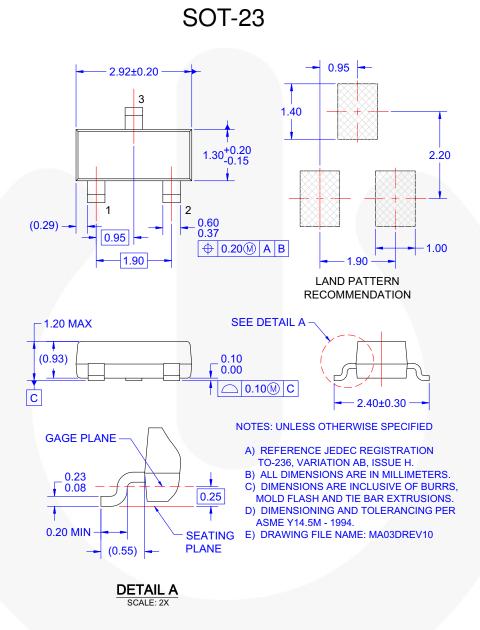


Figure 18. 3-LEAD, SOT23, JEDEC TO-236, LOW PROFILE

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: http://www.fairchildsemi.com/dwg/MA/MA03D.pdf.

For current tape and reel specifications, visit Fairchild Semiconductor's online packaging area: http://www.fairchildsemi.com/packing dwg/PKG-MA03D.pdf.

Physical Dimensions (Continued)

SOT-223 4L

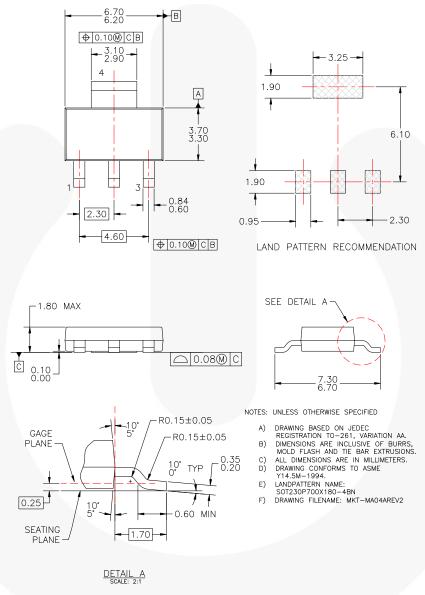


Figure 19. MOLDED PACKAGE, SOT-223, 4-LEAD

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: http://www.fairchildsemi.com/dwg/MA/MA04A.pdf.

For current tape and reel specifications, visit Fairchild Semiconductor's online packaging area: http://www.fairchildsemi.com/packing_dwg/PKG-MA04A_BK.pdf.





TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

F-PFS™ AccuPower™ AX-CAP® FRFFT® Global Power ResourceSM BitSiC™ Build it Now™ GreenBridge™

Green FPS™ CorePLUS™ CorePOWER™ Green FPS™ e-Series™

Gmax™ $CROSSVOLT^{\text{\tiny TM}}$ CTL^TM GTO™ IntelliMAX™ Current Transfer Logic™ **DEUXPEED®** ISOPLANAR™

Making Small Speakers Sound Louder and Better™ Dual Cool™

EcoSPARK® EfficientMax™ MegaBuck™ ESBC™ MICROCOUPLER™

MicroFET™ MicroPak™ MicroPak2™ MillerDrive™ MotionMax™ mWSaver[®] OptoHiT™

OPTOLOGIC® OPTOPLANAR® PowerTrench® PowerXS™

Programmable Active Droop™

QS™ Quiet Series™ RapidConfigure™

Saving our world, 1mW/W/kW at a time™ SignalWise™

SmartMax™ SMART START™

Solutions for Your Success™

SPM[®] STEALTH™ SuperFET® SuperSOT™-3 SuperSOT™-6 SuperSOT™-8 SupreMOS® SyncFET™ Sync-Lock™

SYSTEM GENERAL®* TinyBoost®

TinyBuck[®] TinyCalc™ TinyLogic[®] TINYOPTO™ TinyPower™ TinyPWM™ TinyWire™ TranSiC™

TriFault Detect™ TRUECURRENT®* μSerDes™

UHC[®] Ultra FRFET™ UniFET™ VCX^{TM} VisualMax™ VoltagePlus™ XS™ 仙童™

DISCLAIMER

Fairchild®

FACT® FAST®

FastvCore™

FETBench™

Fairchild Semiconductor®

FACT Quiet Series™

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN. WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Torms

Definition of Terms				
Datasheet Identification	Product Status	Definition		
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.		
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.		

Rev 168

^{*} Trademarks of System General Corporation, used under license by Fairchild Semiconductor.